

BigTwin SuperServer SYS-221BT-DNC8R

2U 2-Node BigTwin with 12 hot-swap 2.5" NVMe/SAS/SATA drives per node



Key Applications

All-Flash Hyperconverged Infrastructure, All-Flash Storage Area Network, All-Flash Object Storage,

Key Features

- Socket E (LGA 4677) support 5th/4th Gen Intel® Xeon® Scalable processors;
- Intel® C741:
- 16 DIMM Slots supporting up to 4TB of memory; ECC RDIMMs up to DDR5-5600;
- Internal PCIe 4.0 x8 for 2 M.2 NVMe support onboard
 1 PCIe 5.0 x16 (LP) slot; 1 PCIe 5.0 x8 (LP) slot; Tool-less support
 Optional M.2 (22x80) HW RAID1 NVMe Boot Controller via SCC-A2NM2241G3-R1.
- Network connectivity via AIOM (OCP 3.0 compliant);
- Built-in SAS3 Support via Broadcom 3816; IT Mode 12 hot-Swap 2.5" drive bays (2x PCIe 5.0 NVMe/SAS and 10x PCIe 4.0 NVMe/SAS);
- Liquid Cooling Support
 - 4 cooling fans per 2U enclosure, 16.5K RPM; Shared Cooling Design;
- 2200W Redundant Power Supplies Titanium Level (96%+); Shared Power

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the following:;	Enclosure: 449 x 88 x 730mm (17.68" x 3.47" x 28.75")
_	Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")

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5th Gen Intel® Xeon® / 4th Gen Intel® Xeon® Scalable processors

Supports Intel Xeon CPU Max Series with high bandwidth memory (HBM)

Up to 64C/128T; Up to 320MB Cache per CPU

System Memory Slot Count: 16 DIMM slots

Max Memory (1DPC): Up to 4TB 5600MT/s ECC DDR5 RDIMM

Drive Bays Configuration Default: Total 12 bays

 $\bullet~$ 2 front hot-swap 2.5" PCIe 5.0 NVMe/SAS drive bays

• 10 front hot-swap 2.5" PCIe 4.0 NVMe/SAS drive bays

M.2: 2 M.2 PCIe 4.0 x4 NVMe slots (M-key 22110(default); VROC required for RAID)

Expansion Slots Default

1 PCIe 5.0 x8 LP slot1 PCIe 5.0 x16 LP slot

On-Board Devices SAS: SAS (12Gbps) via Broadcom® 3816; (IT mode)

Chipset: Intel® C741

Network Connectivity: Via AIOM

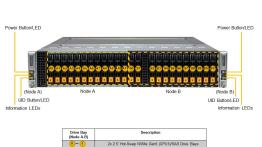
Input / Output LAN: 1 RJ45 1 GbE Dedicated BMC LAN port

USB: 2 USB 3.0 Gen2 Type-A ports(Rear)

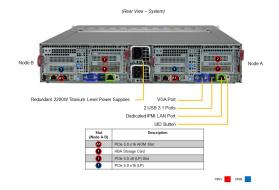
Video: 1 VGA port







(Front View - System)



(Node A-B)	
0-1	2x 2.5" Hot-Swap NVMe Gen5 (CPU1)/SAS Drive Bays
2-3	2x 2.5" Hot-Swap NVMe Gen4 (CPU1)/SAS Drive Bays
4-11	8x 2.5" Hot-Swap NVMe Gen4 (CPU2)/SAS Drive Bay

System Cooling	Fans: 4x 16.5K RPM Heavy Duty 8cm Fan(s) Liquid Cooling: Direct to Chip (D2C) Cold Plate (optional)
Power Supply	2x 2200W Redundant (1 + 1) Titanium Level (96%) power supplies
System BIOS	BIOS Type: AMI 32MB Flash ROM
Management	SuperCloud Composer; Supermicro Server Manager (SSM); Supermicro Update Manager (SUM); Supermicro SuperDoctor® 5 (SD5); Super Diagnostics Offline (SDO); Supermicro Thin-Agent Service (TAS); SuperServer Automation Assistant (SAA) New!
PC Health Monitoring	FAN: Fans with tachometer monitoring Status monitor for speed control Pulse Width Modulated (PWM) fan connectors Temperature: Monitoring for CPU and chassis environment CPU: Monitors for CPU Cores, Chipset Voltages, Memory. 8+4 Phase-switching voltage regulator
Dimensions and Weight	Weight: Gross Weight: 80.7 lbs (36.6 kg) Net Weight: 55.1 lbs (25 kg) Available Color: Black front & silver body
Operating Environment	RoHS Compliant Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F) Non-operating Temperature: -30°C to 60°C (-22°F to 140°F) Operating Relative Humidity: 8% to 80% (non-condensing) Non-operating Relative Humidity: 8% to 90% (non-condensing)
Motherboard	Super X13DET-B
Chassis	CSE-217BD2-R2K22P